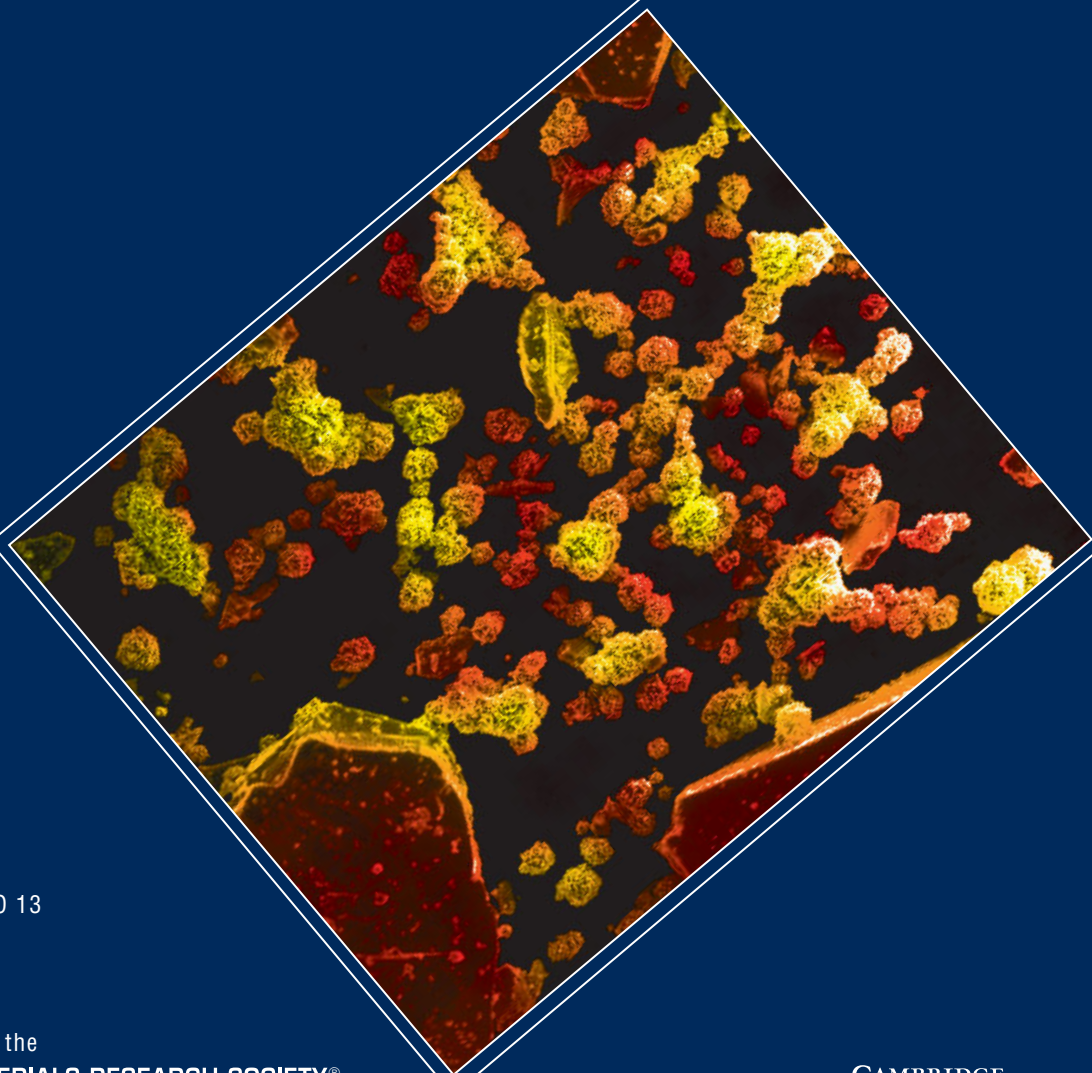


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Cover: FIG. 3(a). Scanning electron micrograph of the powder blend in the as-blended (unmilled) condition showing elemental Ni and Ge powder particles. [C. Suryanarayana and A. Al-Jouhori: Reversible transformation of NiGe in mechanically alloyed Ni-Ge powders. p. 2124].

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